

## SSC8LA22GN6

#### **N-Channel Enhancement Mode MOSFET**

#### Features

V <sub>DS</sub>	V <sub>GS</sub>	R <sub>DS(ON)</sub> Typ.	l <sub>D</sub>
100V	+20V	4.4mΩ@10V	112A
	<u> </u>	5.7mΩ@4V5	HZA

#### Description

This device is N-Channel enhancement MOSFET.

Uses SGT technology and design to provide excellent

RDSON with low gate charge. This device is suitable
for use in DC-DC conversion, power switch and
charging circuit.

#### 100% UIS + ΔVDS + Rg Tested!

#### Applications

- DC/DC converters
- Power supplies
- Motor Drive Control
- Synchronous rectification

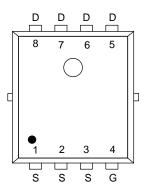
#### Ordering Information

Device	Package	Shipping	
SSC8LA22GN6	PDFN5X6-8L	5000/Reel	

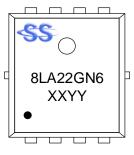
## > Pin Configuration



PDFN5X6-8L



**Pin Configuration (Top View)** 



**Marking** 

(XXYY: Internal Traceability Code)



### ➤ Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit	
$V_{DSS}$	Drain-to-Source Volta	Drain-to-Source Voltage		V
V <sub>GSS</sub>	Gate-to-Source Volta	ge	±20	V
	Cartinosas Duain Commente		112	Δ.
I <sub>D</sub>	Continuous Drain Current	T <sub>C</sub> =100℃	62	- A
	Outine Dair Out 1	T <sub>A</sub> =25℃	18	Δ.
IDSM	I <sub>DSM</sub> Continuous Drain Current <sup>a</sup>	T <sub>A</sub> =70°C	13	- A
Ірм	Pulsed Drain Curren	Pulsed Drain Current <sup>b</sup>		Α
Б	Danier Diagination C	Tc=25℃	114	10/
P <sub>D</sub>	Power Dissipation •	$T_{C}=25^{\circ}C$ $T_{C}=100^{\circ}C$ $T_{A}=25^{\circ}C$ $T_{A}=70^{\circ}C$ $T_{C}=100^{\circ}C$ $T_{C}=100^{\circ}C$ $T_{A}=25^{\circ}C$ $T_{A}=70^{\circ}C$ $T_{A}=70^{\circ}C$ $T_{A}=70^{\circ}C$ $T_{C}=100^{\circ}C$ $T_{C}=100^{$	46	W
	Danier Diagination 2	tinuous Drain Current $^d$ $T_C=100^{\circ}C$ $T_A=25^{\circ}C$ $T_A=70^{\circ}C$ Pulsed Drain Current $^b$ Power Dissipation $^c$ $T_C=100^{\circ}C$ $T_C=100^{\circ}C$ $T_C=100^{\circ}C$ $T_A=25^{\circ}C$ $T_A=70^{\circ}C$ Avalanche Current $^b$ L=0.5mH Single Pulse  Avalanche Energy $^b$ L=0.5mH Single Pulse	2.9	W
P <sub>DSM</sub>	Power Dissipation a	T <sub>A</sub> =70°C	1.9	
las	Avalanche Current <sup>b</sup> L=0.5mH Single Pulse		21	Α
Eas	Avalanche Energy <sup>b</sup> L=0.5mH Single Pulse		110	mJ
TJ	Operation junction temperature		-55~150	°C
T <sub>STG</sub>	Storage temperature ra	ange	-55~150	$^{\circ}\mathbb{C}$

#### ➤ Thermal Resistance Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Max.	Unit
R <sub>θJA</sub>	Junction-to-Ambient Thermal Resistance <sup>a</sup>	43	60	°C/W
$R_{ heta JC}$	Junction-to-Case Thermal Resistance	1.1	1.5	C/VV

#### Note:

- a. The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper, in a still air environment with T<sub>A</sub>=25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation  $P_D$  is based on  $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

SSC-V1.2 www.sscsemi.com Analog Future



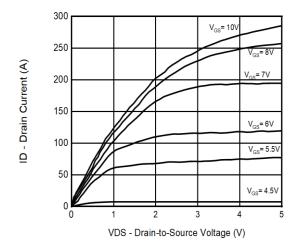
# SSC8LA22GN6

## $\succ$ Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

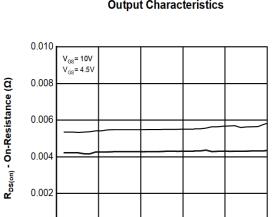
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	100			V
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{DS} = V_{GS}$ , $I_D = 250uA$	1		2.5	V
Drain-Source On-Resistance	D	V <sub>GS</sub> = 10V, I <sub>D</sub> = 30A		4.4	5.7	mΩ
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 20A		5.7	7.4	11122
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V			1	μA
Gate-Source Leak Current	Igss	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100	nA
Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = 30A		0.86	1.3	V
Gate Resistance	R <sub>G</sub>	V <sub>DS</sub> = 0V, f = 1MHz		1.3		Ω
Input Capacitance	Ciss	\/ - 50\/ \/ - 0\/		3781		
Output Capacitance	Coss	$V_{DS} = 50V$ , $V_{GS} = 0V$ , $f = 1MHz$		1038		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>	T I TIVITZ		22		
Total Gate Charge	Q <sub>G</sub>	\\ -40\\\\ -50\\		44		
Gate to Source Charge	Q <sub>G</sub> s	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 50V,		12		nC
Gate to Drain Charge	Q <sub>GD</sub>	- I <sub>D</sub> = 30A		9.8		
Turn-on Delay Time	T <sub>D(ON)</sub>			11		
Rise Time	Tr	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 50V, R <sub>L</sub>		19		<u> </u>
Turn-off Delay Time	T <sub>D(OFF)</sub>	= $1\Omega$ , $R_G = 3\Omega$		26		ns
Fall Time	T <sub>f</sub>			14		
Diode Recovery Time	Trr	I <sub>F</sub> =30A, di/dt=500A/us		31		ns
Diode Recovery Charge	Qrr	I <sub>F</sub> =30A, di/dt=500A/us		195		nC



## Typical Performance Characteristics (T<sub>A</sub>=25℃ unless otherwise noted)

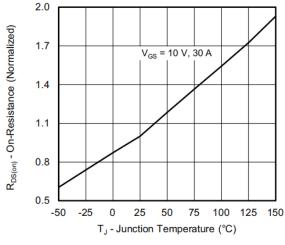


**Output Characteristics** 

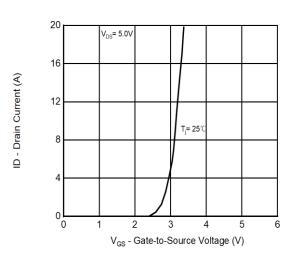


On-Resistance vs. Drain Current and Gate Voltage

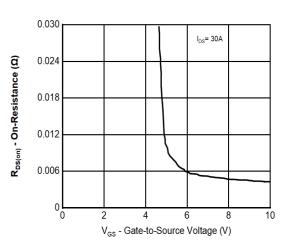
ID - Drain Current (A)



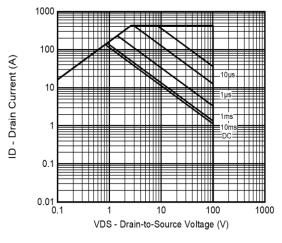
On-Resistance vs. Junction Temperature



**Transfer Characteristics** 

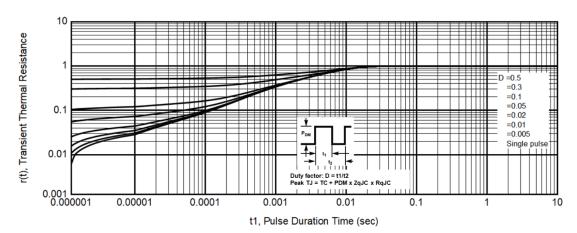


On-Resistance vs. Gate-to-Source Voltage



Safe Operating Area

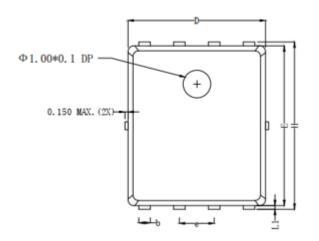


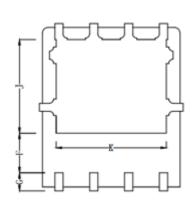


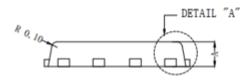
Transient Thermal Resistance, Junction to case

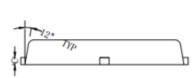


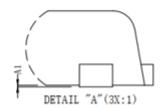
## > Package Information











Symbol	Dimensions In Millimeters				
	Min.	Nom.	Max.		
Α	0.90	1.00	1.10		
A1	0.00	0.03	0.05		
b	0.25	0.03	0.35		
С		0.254 REF			
D	4.80	4.90	5.00		
F	1.35 REF				
E	5.65	5.75	5.85		
е	1.27 BSC				
Н	5.90	6.00	6.10		
L1	0.10	0.13	0.16		
G	0.55 REF				
К	4.00 REF				
J	3.45 REF				



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